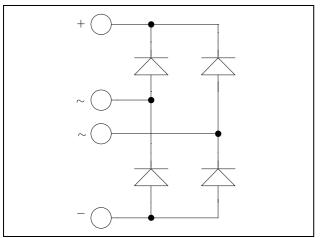
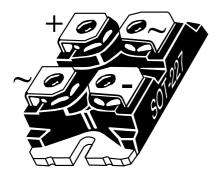


# APT35DL120HJ

# ISOTOP<sup>®</sup> Fast Diode Full Bridge Power Module

## $V_{RRM} = 1200V$ $I_F = 35A$ (a) $Tc = 80^{\circ}C$





#### Application

- Switch mode power supplies rectifier
- Induction heating
- Welding equipment
- High speed rectifiers

#### Features

- Ultra fast recovery times
- Soft recovery characteristics
- High blocking voltage
- High current
- Low leakage current
- Very low stray inductance
- High level of integration
- ISOTOP<sup>®</sup> Package (SOT-227)

#### Benefits

- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant

#### Absolute maximum ratings

Symbol	Parameter			Max ratings	Unit	
V <sub>R</sub>	Maximum DC reverse Voltage			1200	V	
V <sub>RRM</sub>	Maximum Peak Repetitive Revers	e Voltage			1200	v
I <sub>F(AV)</sub>	Maximum Average Forward Current	Duty cycle = 50%		$T_C = 80^{\circ}C$	35	А
I <sub>FRM</sub>	Maximum repetitive forward current limited by T <sub>Jmax</sub> 8		8.3ms	$T_J = 45^{\circ}C$	70	11

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

# APT35DL120HJ-Rev 1 October, 2012



### All ratings (a) $T_j = 25^{\circ}C$ unless otherwise specified

#### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit	
$V_{\rm F}$	Diode Forward Voltage	$I_F = 35A$	$T_j = 25^{\circ}C$		1.6	2.1	V
			$T_{j} = 125^{\circ}C$		1.6		
I <sub>RM</sub>	Maximum Reverse Leakage Current	$V_{R} = 1200V$	$T_i = 25^{\circ}C$			250	μA
		$v_{\rm R} = 1200 v$	$T_{j} = 125^{\circ}C$			500	

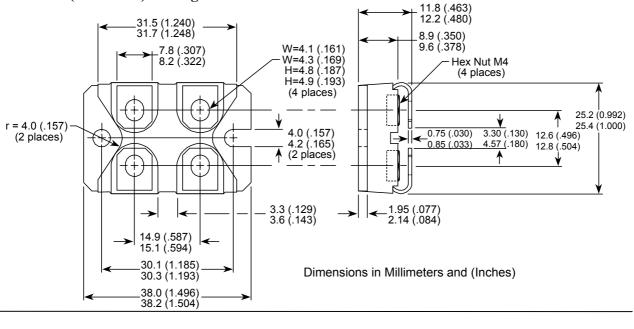
#### **Dynamic Characteristics**

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
t <sub>rr</sub>	Reverse Recovery Time	$I_{F} = 35A \\ V_{R} = 600V \\ di/dt = 1500A/\mu s$	$T_j = 25^{\circ}C$		170		ns
			$T_{i} = 125^{\circ}C$		280		
Q <sub>rr</sub>	Reverse Recovery Charge		$T_j = 25^{\circ}C$		3.5		μC
			$T_{j} = 125^{\circ}C$		7		
E <sub>rr</sub>	Reverse Recovery Energy		$T_j = 25^{\circ}C$		1.4		- mJ
			$T_j = 125^{\circ}C$		2.7		

#### Thermal and package characteristics

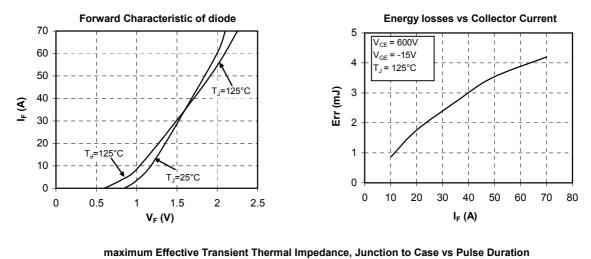
Symbol	Characteristic	Min	Тур	Max	Unit
R <sub>thJC</sub>	Junction to Case Thermal resistance			0.95	°C/W
R <sub>thJA</sub>	Junction to Ambient			20	C/ W
V <sub>ISOL</sub>	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz	2500			V
$T_J, T_{STG}$	Storage Temperature Range	-55		150	°C
T <sub>L</sub>	Max Lead Temp for Soldering:0.063" from case for 10 sec			300	C
Torque	Mounting torque (Mounting = 8-32 or 4mm Machine and terminals = 4mm Machine)			1.5	N.m
Wt	Package Weight		29.2		g

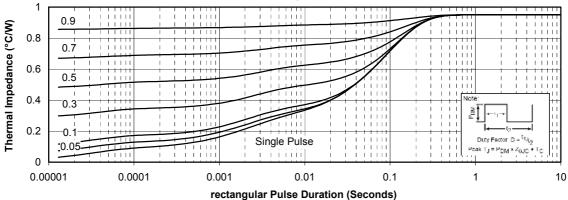
## SOT-227 (ISOTOP<sup>®</sup>) Package Outline





## **Typical Performance Curve**





ISOTOP® is a registered trademark of ST Microelectronics NV



# APT35DL120HJ

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